

65 V, 100 mA NPN general-purpose transistor Rev. 1 — 15 May 2012

Product data sheet

1. **Product profile**

1.1 General description

NPN general-purpose transistor in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package.

1.2 Features and benefits

- Leadless ultra small SMD plastic package
- Low package height of 0.37 mm
- Power dissipation comparable to SOT23
- AEC-Q101 qualified

1.3 Applications

- General-purpose switching and amplification
- Mobile applications

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CEO}	collector-emitter voltage	open base	-	-	65	V
I _C	collector current		-	-	100	mA
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 2 mA	200	-	450	

Pinning information 2.

Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector	2	1-
		Transparent top view	2



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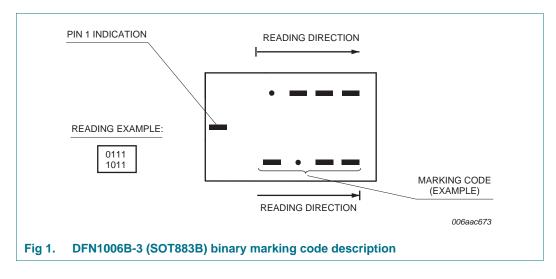
3. Ordering information

Table 3. Orde	ring information		
Type number	Package		
	Name	Description	Version
BC846BMB	DFN1006B-3	leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.37$ mm	SOT883B

4. Marking

Table 4.	Marking codes		
Type num	iber	Marking code	
BC846BM	В	0100 1011	

4.1 Binary marking code description



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5. Limiting values

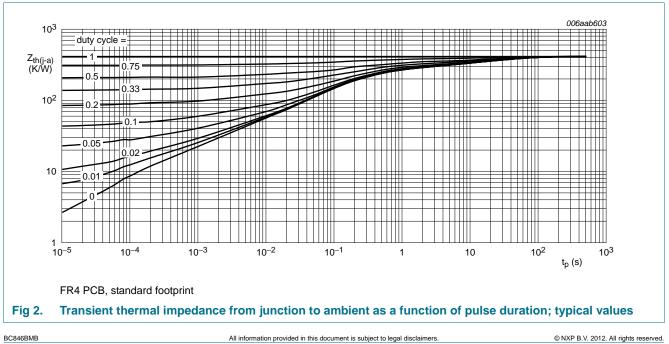
Table 5. In accorda	Limiting values nce with the Absolute Maximu	ım Rating System (I	EC 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	80	V
V _{CEO}	collector-emitter voltage	open base	-	65	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1 ms$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \leq 1 ms$	-	200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	250	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



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7. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO} collector-base cut-off current		$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$		-	-	15	nA
	$\label{eq:VCB} \begin{array}{l} V_{CB} = 30 \; V; \; I_{E} = 0 \; A; \\ T_{j} = 150 \; ^{\circ}C \end{array}$		-	-	5	μA	
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_E = 0 \text{ A}$		-	-	100	nA
h _{FE}	DC current gain	V_{CE} = 5 V; I_{C} = 2 mA		200	-	450	
OLGUI	collector-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$		-	90	200	mV
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	[1]	-	200	400	mV
V _{BEsat} base-emitter saturation voltage	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$	[2]	-	760	-	mV	
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 5 \text{ mA}$	[2]	-	900	-	mV
V _{BE} base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$	[3]	580	660	700	mV	
		I_{C} = 10 mA; V_{CE} = 5 V	[3]	-	-	770	mV
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz		100	-	-	MHz
C _c	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \\ f = 1 \text{ MHz} \end{array}$		-	2	3	pF
C _e	emitter capacitance	$\label{eq:Veb} \begin{array}{l} V_{EB}=0.5 \text{ V}; \text{ I}_{C}=\text{i}_{c}=0 \text{ A};\\ f=1 \text{ MHz} \end{array}$		-	11	-	pF
NF	noise figure	$I_{C} = 200 \ \mu$ A; V _{CE} = 5 V; R _S = 2 kΩ; f = 1 kHz; B = 200 Hz		-	2	10	dB

[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02$.

[2] V_{BEsat} decreases by approximately 1.7 mV/K with increasing temperature.

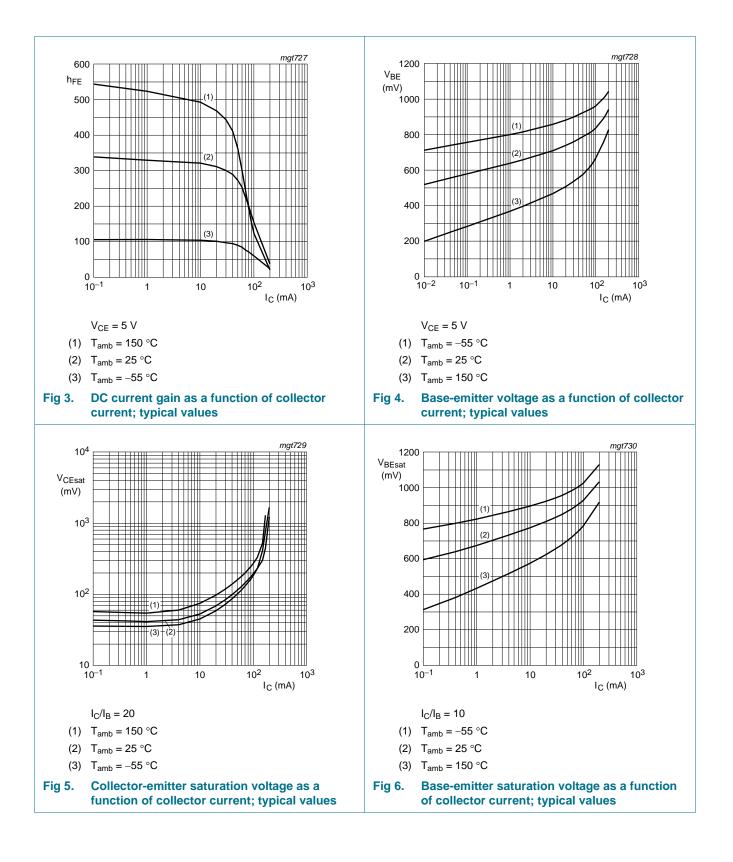
[3] V_{BE} decreases by approximately 2 mV/K with increasing temperature.

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BC846BMB

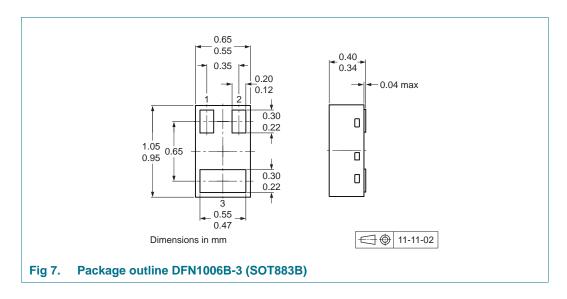
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8. Test information

9. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

10. Package outline



11. Packing information

 Table 8.
 Packing methods

 The indicated -xxx are the last three digits of the 12NC ordering code.[1]

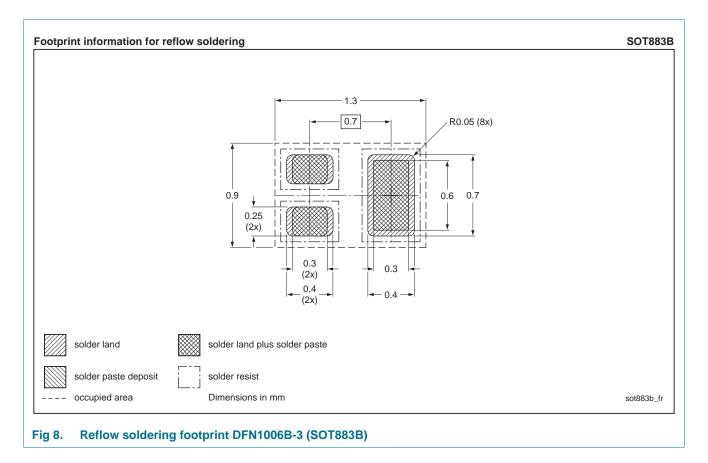
Туре	e number	Package	Description	Packing quantity
				10000
BC8	46MBM	SOT883B	2 mm pitch, 8 mm tape and reel	-315

[1] For further information and the availability of packing methods, see <u>Section 15</u>.

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12. Soldering



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13. Revision history

Table 9.	Revision histo	ory			
Document	t ID	Release date	Data sheet status	Change notice	Supersedes
BC846BM	B v.1	20120515	Product data sheet	-	-

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14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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